



CCM: high - forces CCM
 low - allows DCM
 PFM: high - disables PFM mode
 low - allows PFM

Rev B:
 1) short pin 16 "SWN" to GND
 2) used D3 ZENER 3.6V for OVP
 3) inserted gate resistors R10, R11 10 Ohm
 4) tuned loop

NOTES:
 1) R13 for test purposes only
 2) built on PCB 30284 RevA

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Orderable:	Designed for:	Mod. Date: 7/28/2017
TID #:	Project Title: tiny LED driver	
Number: PMP30284	Rev: A	Sheet Title: 1s to 2s single LED driver
Assembly Variant: [No Variations]	Assembly Variant: [No Variations]	Sheet: 1 of 1
Drawn By:	File: PMP30284RevB_schematic.SchDoc	Size: B
Engineer: B.Geck	Contact: TechSupport	



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